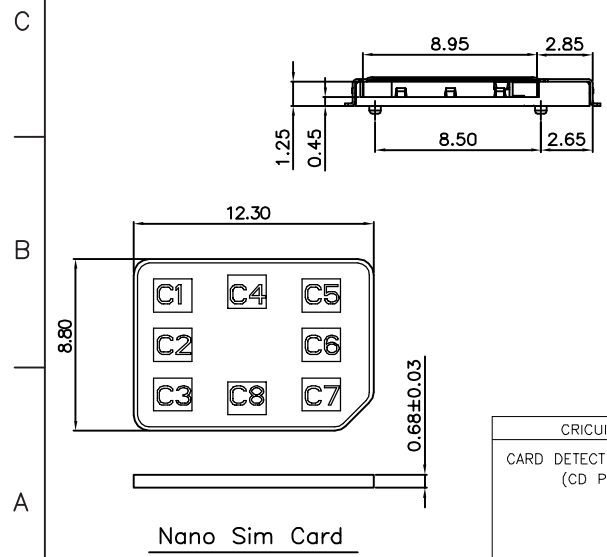
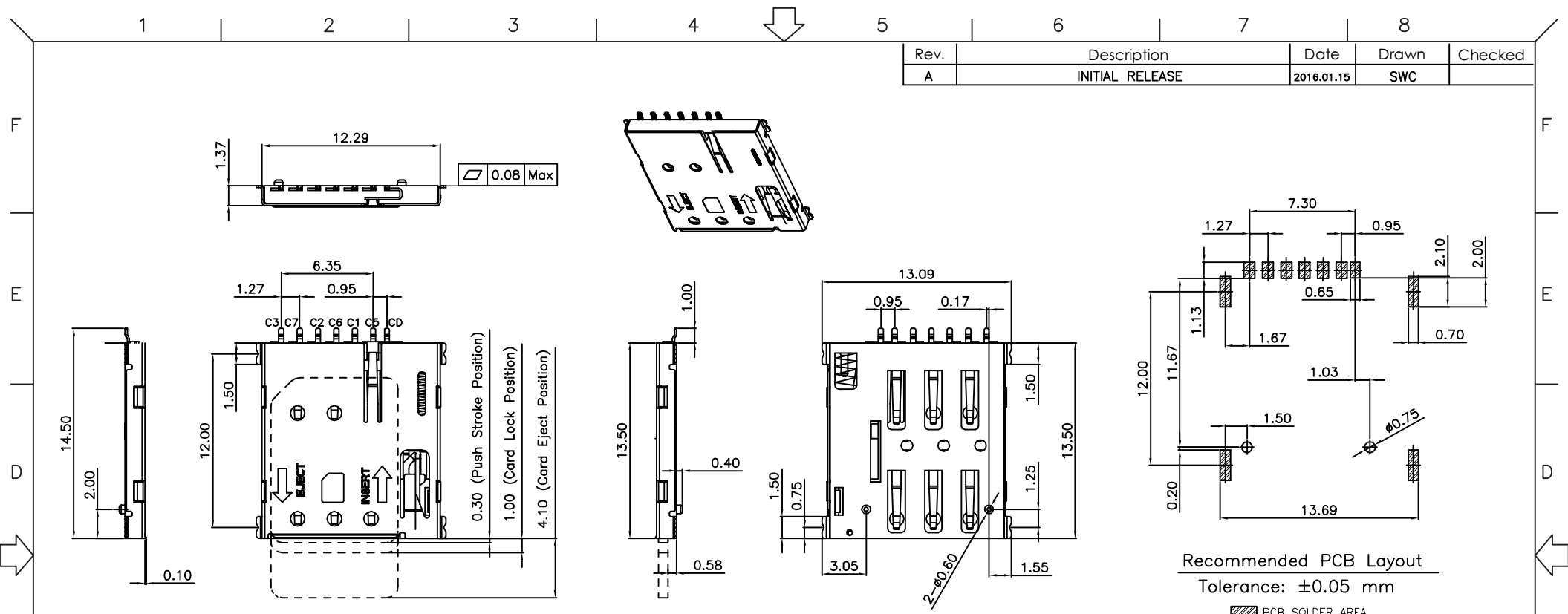


Rev.	Description	Date	Drawn	Checked
A	INITIAL RELEASE	2016.01.15	SWC	



**1. Materials**  
Housing: Thermoplastic, UL 94V-0, Black  
Terminal: Copper Alloy, Nickel Under Plated Overall  
Gold Plated On Contact Area.  
Shell: SUS, Nickel Plated Overall.  
Gold Plated On Contact Area.

**2. Specifications:**  
Current Rating: 0.5 AMP AC/DC Max.  
Dielectric Withstanding: 500V AC For One Minute

Contact Resistance: 100m Ohms Max.  
Insulation Resistance: 1000M OHMS MIN. AT DC 250V  
Operation Temperature: -25°C~+85°C

**3. Part No.**  
2SM40GJH - 06 X X - 1 2 0 L

Series: Nano SIM Card  
No Of Pos.: 06  
Package: 2: Tape Reel  
Plated On Solder Tails:  
A: Au  
T: Tin

Contact Plated:  
1: Gold Flash  
Lead Free

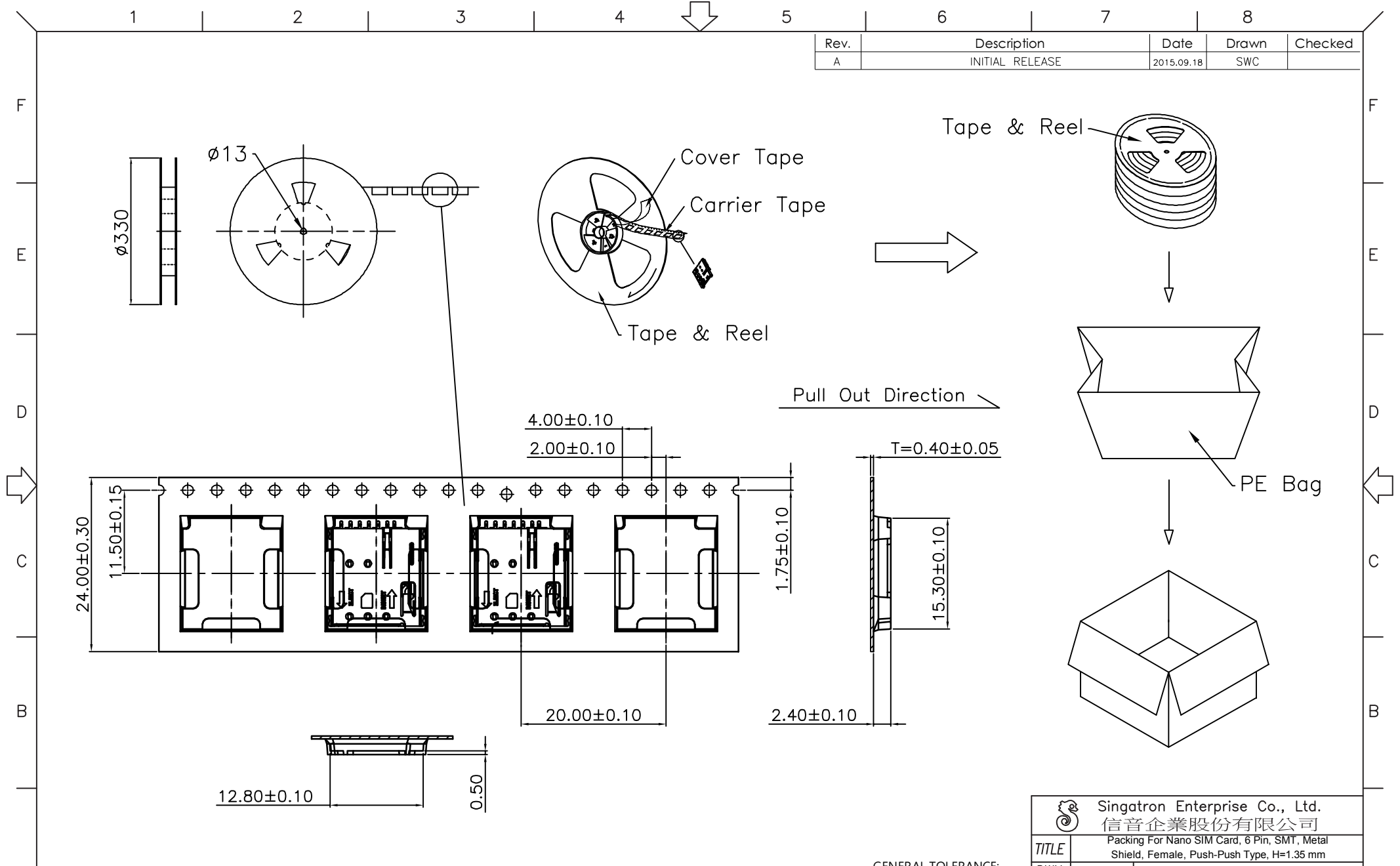
Nano SIM Card

Pin No.	Port Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	1/0

GENERAL TOLERANCE:  
.X  $\pm$ 0.30 Ang.  $\pm$ 3°  
.XX  $\pm$ 0.20  
.XXX  $\pm$ 0.10

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TITLE	Nano SIM Card, 6 PIN, SMT, Metal Shield, Female, Push-Push Type, H=1.35 mm		
DWN	SWC2016.01.15	PART NO. 2SM40GJH-06XX-120L	
CHKD	SCALE 1:1	UNIT: mm	
APVD	SIZE: A3	SHEET: 1 OF 1	REV: A
<b>CUSTOMER COPY</b>			

Rev.	Description	Date	Drawn	Checked
A	INITIAL RELEASE	2015.09.18	SWC	



Part No.	Reel/PCS	Carton/Reel	Carton/PCS
2SM40GJH-06XX-120L	1/1000	1/5	1/5000

GENERAL TOLERANCE:  
 .X ±0.30    Ang. ±3°  
 .XX ±0.20  
 .XXX ±0.10

Singatron Enterprise Co., Ltd. 信音企業股份有限公司			
TITLE: Packing For Nano SIM Card, 6 Pin, SMT, Metal Shield, Female, Push-Push Type, H=1.35 mm			
DWN	SWC2015.09.18	PART NO.	PK-2SM40GJH-06XX-120L
CHKD		SCALE	1:1 UNIT: mm
APVD		SIZE	A3 SHEET: 1 OF 1 REV: A
<b>CUSTOMER COPY</b>			